

2A, 400V - 1000V Glass Passivated Bridge Rectifier

FEATURES

- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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 General purpose use in AC/DC bridge full wave rectification for SMPS, especially for the space constrained appliances applications

MECHANICAL DATA

Case: KBPF

• Molding compound meets UL 94V-0 flammability rating

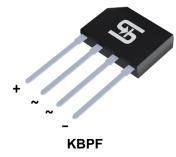
• Terminal: Matte tin plated leads, solderable per J-STD-002

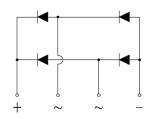
Polarity: As marked

• Weight: 1.4 g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I _F	2	Α				
V_{RRM}	400 - 1000	V				
I _{FSM}	60	Α				
T _{J MAX}	150	°C				
Package	KBPF					
Configuration	Quad					







	SYMBOL	KBPF	KBPF	KBPF	KBPF	
PARAMETER		204G	205G	206G	207G	UNIT
Marking code on the device		KBPF 204G	KBPF 205G	KBPF 206G	KBPF 207G	
Repetitive peak reverse voltage	V_{RRM}	400	600	800	1000	٧
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	560	700	٧
Forward current	I _F	2			А	
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	60			А	
Rating of fusing (t<8.3ms)	l ² t	15			A ² s	
Junction temperature	T_J	- 55 to +150			°C	
Storage temperature	T _{STG}	- 55 to +150			°C	



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THERMAL PERFORMANCE							
PARAMETER	SYMBOL	TYP.	UNIT				
Junction-to-lead thermal resistance	$R_{\Theta JL}$	12	°C/W				
Junction-to-ambient thermal resistance	R _{ÐJA}	55	°C/W				
Junction-to-case thermal resistance	R _{eJC}	13	°C/W				

Thermal Performance Note: Units mounted on PCB (10mm x 10mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)							
PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT		
Forward valtage per diade (1)	$I_F = 1A, T_J = 25^{\circ}C$	\/	-	1.1	V		
Forward voltage per diode (1)	$I_F = 1A, T_J = 125$ °C	V_{F}	-	1.0	V		
Deverage surrent @ reted V new diade (2)	T _J = 25°C		-	5	μA		
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 125°C	I _R	-	50	μA		
Junction capacitance	1 MHz, V _R =4.0V	CJ	18	-	pF		

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION						
ORDERING CODE	PACKAGE	PACKING				
KBPF204G C8G	KBPF	35 / TUBE				
KBPF205G C8G	KBPF	35 / TUBE				
KBPF206G C8G	KBPF	35 / TUBE				
KBPF207G C8G	KBPF	35 / TUBE				

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CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

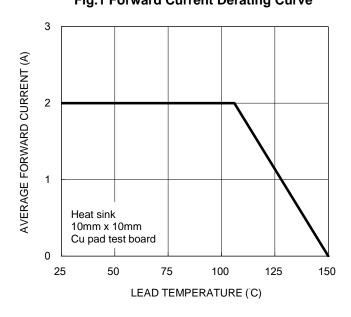


Fig.2 Typical Junction Capacitance

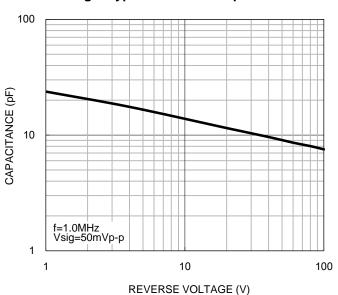


Fig.3 Typical Reverse Characteristics

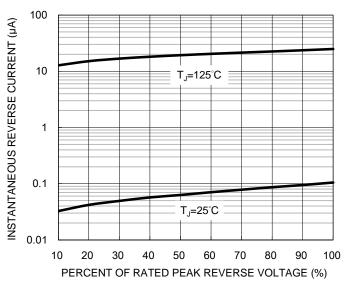
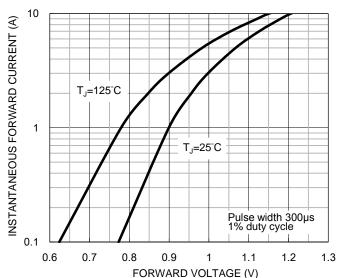


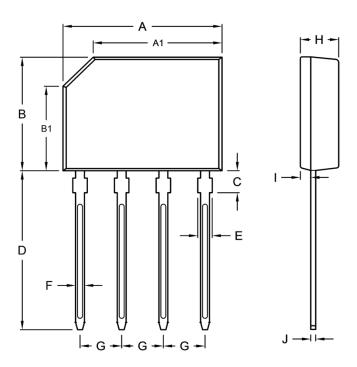
Fig.4 Typical Forward Characteristics





PACKAGE OUTLINE DIMENSIONS

KBPF



DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	14.25	14.75	0.561	0.581	
A1	11.45	12.05	0.451	0.474	
В	10.10	10.60	0.398	0.417	
B1	7.40	8.00	0.291	0.315	
С	1.80	2.20	0.071	0.087	
D	14.25	14.73	0.561	0.580	
E	1.22	1.42	0.048	0.056	
F	0.76	0.86	0.030	0.034	
G	3.70	3.90	0.146	0.154	
Н	3.35	3.65	0.132	0.144	
I	0.80	1.10	0.031	0.043	
J	0.35	0.55	0.014	0.022	

MARKING DIAGRAM



P/N = Marking Code G =Green Compound

YWW = Date Code F = Factory Code

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